

WHAT IS CLAIMED IS:

1. An optical interconnection device comprising an optical waveguide layer, wherein the waveguide layer is equipped with a plurality of electrodes  
5 which are independently drive-controllable such that a refractive index distribution is generated in the waveguide layer by drive control of the electrodes to control a propagation state of light in the waveguide layer, and an optical interconnection port is  
10 provided on an upper or lower surface or inside of the waveguide layer.

2. The optical interconnection device according to claim 1, wherein the optical interconnection port  
15 is comprised of an optical element for receiving or emitting a light in a direction approximately perpendicular to a light-waveguiding surface and an optical path conversion means provided corresponding to the optical element at a given position in the  
20 waveguide layer.

3. The optical interconnection device according to claim 2, wherein the optical path conversion means is a light reflector with a convex shape, and the  
25 optical element is a plurality of surface elements arranged around a top of the convex of the light reflector with their centers deviated from the top of

the convex such that each optical element effects emission or reception only to and from a limited region within the waveguide layer.

5           4. The optical interconnection device according to claim 2, wherein the optical element is a surface element comprised of a semiconductor crystal and has such a constitution that only a thin film layer necessary for receiving or emitting light of the  
10 semiconductor crystal is transferred to the waveguide layer and a semiconductor substrate is omitted.

          5. The optical interconnection device according to claim 1, wherein the drive-controllable electrodes  
15 are divided in plurality and provided on one side or both sides of the waveguide layer.

          6. The optical interconnection device according to claim 5, wherein the drive-controllable electrodes  
20 are a plurality of heaters provided on a surface of the waveguide layer and a refractive index distribution is generated in the waveguide layer by temperature control with the electrodes.

25           7. The optical interconnection device according to claim 5, wherein the drive-controllable electrodes are provided in plurality on a surface of the.

waveguide layer so as to enable local electric-field application and a refractive index distribution is generated in the waveguide layer by electric-field control with the electrodes.

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8. A photoelectric mixedly mounted device comprising integrally the optical interconnection device set forth in claim 1, an electronic device connected to an optical interconnection port provided  
10 in the optical interconnection device and an electric wiring layer.

9. The photoelectric mixedly mounted device according to claim 8, having a package form equipped  
15 with a connection terminal for electric connection with the outside.

10. The photoelectric mixedly mounted device according to claim 8, having a connection port for  
20 optical interconnection to the outside.

11. The photoelectric mixedly mounted device according to claim 8, having such a configuration that a pattern of a manner of optical interconnection  
25 of the photoelectric mixedly mounted device is stored in a memory inside or outside of device, and the pattern is read from the memory in accordance with an

instruction to change the optical interconnection to switch an operation of the device.

12. The photoelectric mixedly mounted device  
5 according to claim 8, having such a configuration  
that a pattern of a manner of optical interconnection  
of the photoelectric mixedly mounted device is  
downloaded as a design asset from outside of the  
device and rewritten, and an operation of the device  
10 is switched on the downloading.

13. An electronic equipment comprising the  
photoelectric mixedly mounted device set forth in any  
one of claims 8 to 12 to have such a configuration  
15 that connections between IC chips is freely  
reconfigured and a plurality of built-in systems are  
switched by one equipment.